

### The TRENCHSTOP™ 5 WR5 technology in the TO-247-3-HCC package offers improved reliability against package contamination

#### Features

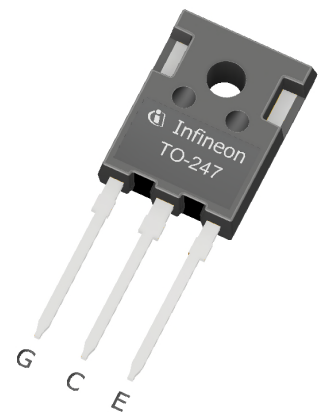
- $V_{CE} = 650\text{ V}$
- $I_C = 30\text{ A}$
- Pin-to-pin creepage distance > 4.8 mm
- Pin-to-pin clearance distance > 3.4 mm
- Monolithic diode optimized for PFC and welding applications
- Stable temperature behavior
- Very low  $V_{CEsat}$  and low  $E_{off}$
- Easy parallel switching capability based on positive temperature coefficient of  $V_{CEsat}$
- Low temperature dependence of  $V_{CEsat}$  and  $E_{sw}$
- Product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

#### Potential applications

- PFC
- Welding
- ZCS applications

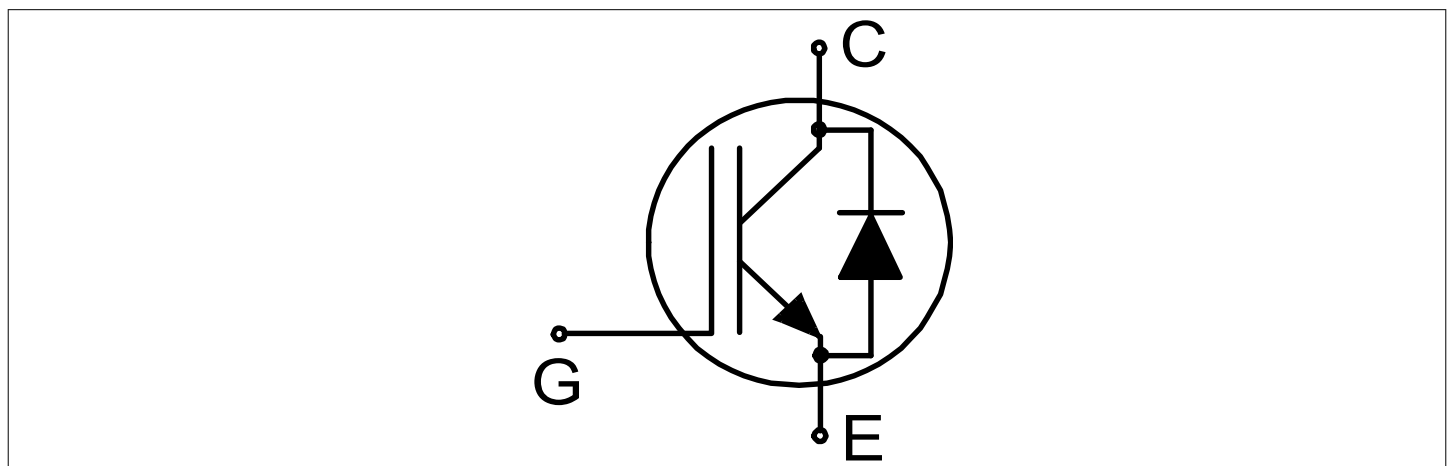
#### Product validation

- Product Validation: Qualified for industrial applications according to the relevant tests of JEDEC47/20/22



- Lead-Free
- Green
- Halogen-Free
- RoHS

#### Description



Type	Package	Marking
IKWH30N65WR5	PG-TO247-3-HCC	H30EWR5

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1 Package

## 1 Package

**Table 1** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in) from case	$L_E$			13.0		nH
Storage temperature	$T_{stg}$		-55		150	°C
Soldering temperature		wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque, M3 screw Maximum of mounting processes: 3	$M$				0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W

## 2 IGBT

**Table 2** Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Collector-emitter voltage	$V_{CE}$	$T_{vj} \geq 25 \text{ °C}$	650	V	
DC collector current, limited by $T_{vjmax}$	$I_C$		$T_C = 25 \text{ °C}$	60	A
			$T_C = 100 \text{ °C}$	30	
Pulsed collector current, $t_p$ limited by $T_{vjmax}$	$I_{Cpuls}$		90	A	
Turn-off safe operating area		$V_{CE} \leq 650 \text{ V}, t_p \leq 1 \text{ }\mu\text{s}, T_{vj} \leq 175 \text{ °C}$	90	A	
Gate-emitter voltage	$V_{GE}$		$\pm 20$	V	
Transient gate-emitter voltage	$V_{GE}$	$t_p \leq 10 \text{ }\mu\text{s}, D < 0.010$	$\pm 20$	V	
Power dissipation	$P_{tot}$		$T_C = 25 \text{ °C}$	190	W
			$T_C = 100 \text{ °C}$	95	

**Table 3** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter breakdown voltage	$V_{BRCES}$	$I_C = 0.2 \text{ mA}, V_{GE} = 0 \text{ V}$	650			V
Collector-emitter saturation voltage	$V_{CE sat}$	$I_C = 30.0 \text{ A}, V_{GE} = 15 \text{ V}$	$T_{vj} = 25 \text{ °C}$	1.40	1.70	V
			$T_{vj} = 175 \text{ °C}$	1.65		

**Table 3 Characteristic values (continued)**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Gate-emitter threshold voltage	$V_{GEth}$	$I_C = 0.30 \text{ mA}, V_{CE} = V_{GE}$	3.20	4.00	4.80	V
Zero gate voltage collector current	$I_{CES}$	$V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		40	$\mu\text{A}$
			$T_{vj} = 175 \text{ }^\circ\text{C}$		0.5	mA
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}$			100	nA
Transconductance	$g_{fs}$	$I_C = 30.0 \text{ A}, V_{CE} = 20 \text{ V}$		67.0		S
Input capacitance	$C_{ies}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$		3230		pF
Output capacitance	$C_{oes}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$		32		pF
Reverse transfer capacitance	$C_{res}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$		13		pF
Gate charge	$Q_G$	$I_C = 30.0 \text{ A}, V_{GE} = 15 \text{ V}, V_{CE} = 520 \text{ V}$		133		nC
Turn-on delay time	$t_{don}$	$V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 27.0 \text{ } \Omega,$ $R_{Goff} = 27.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$	$T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		41	ns
			$T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		33	
Rise time (inductive load)	$t_r$	$V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 27.0 \text{ } \Omega,$ $R_{Goff} = 27.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$	$T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		20	ns
			$T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		21	
Turn-off delay time	$t_{doff}$	$V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 27.0 \text{ } \Omega,$ $R_{Goff} = 27.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$	$T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		398	ns
			$T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		458	
Fall time (inductive load)	$t_f$	$V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 27.0 \text{ } \Omega,$ $R_{Goff} = 27.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$	$T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		18	ns
			$T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		18	
Turn-on energy	$E_{on}$	$V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 27.0 \text{ } \Omega,$ $R_{Goff} = 27.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$	$T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		0.87	mJ
			$T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		1.04	
Turn-off energy	$E_{off}$	$V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 27.0 \text{ } \Omega,$ $R_{Goff} = 27.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$	$T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		0.40	mJ
			$T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 30.0 \text{ A}$		0.70	

**Table 3** Characteristic values (continued)

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Total switching energy	$E_{ts}$	$V_{CE} = 400\text{ V}$ , $V_{GE} = 15\text{ V}$ , $R_{Gon} = 27.0\ \Omega$ , $R_{Goff} = 27.0\ \Omega$ , $L_{\sigma} = 30\text{ nH}$ , $C_{\sigma} = 28\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$ , $I_C = 30.0\text{ A}$		1.27		mJ
			$T_{vj} = 175\text{ }^{\circ}\text{C}$ , $I_C = 30.0\text{ A}$		1.74		
IGBT thermal resistance, junction-case	$R_{thjc}$				0.80	K/W	
Operating junction temperature	$T_{vj}$		-40		175	$^{\circ}\text{C}$	

Note: Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified.

### 3 Diode

**Table 4** Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj} \geq 25\text{ }^{\circ}\text{C}$	650	V	
Diode forward current, limited by $T_{vjmax}$	$I_F$		$T_C = 25\text{ }^{\circ}\text{C}$	23	A
			$T_C = 100\text{ }^{\circ}\text{C}$	13	
Diode pulsed current, limited by $T_{vjmax}$	$I_{Fpuls}$		45	A	

**Table 5** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Diode forward voltage	$V_F$	$I_F = 12.0\text{ A}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$		1.30	1.60	V
			$T_{vj} = 175\text{ }^{\circ}\text{C}$		1.35		
Diode reverse recovery time	$t_{rr}$	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$ , $I_F = 15.0\text{ A}$ , $-di_F/dt = 1400\text{ A}/\mu\text{s}$		79		ns
			$T_{vj} = 175\text{ }^{\circ}\text{C}$ , $I_F = 15.0\text{ A}$ , $-di_F/dt = 1300\text{ A}/\mu\text{s}$		109		

**Table 5** Characteristic values (continued)

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode reverse recovery charge	$Q_{rr}$	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C},$ $I_F = 15.0\text{ A},$ $-di_F/dt = 1400\text{ A}/\mu\text{s}$		1.90		$\mu\text{C}$
					2.60		
Diode peak reverse recovery current	$I_{rrm}$	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C},$ $I_F = 15.0\text{ A},$ $-di_F/dt = 1400\text{ A}/\mu\text{s}$		28.6		A
					39.0		
Diode peak rate off fall of reverse recovery current	$di_{rr}/dt$	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C},$ $I_F = 15.0\text{ A},$ $-di_F/dt = 1400\text{ A}/\mu\text{s}$		-513		$\text{A}/\mu\text{s}$
					-749		
Diode thermal resistance, junction-case	$R_{thjc}$					3.30	K/W
Operating junction temperature	$T_{vj}$			-40		175	$^{\circ}\text{C}$

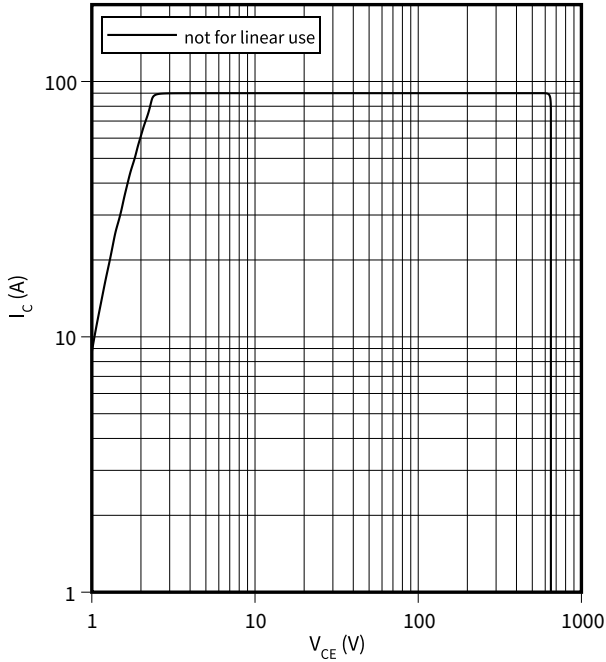
*Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.*

## 4 Characteristics diagrams

### Forward bias safe operating area, IGBT

$$I_C = f(V_{CE})$$

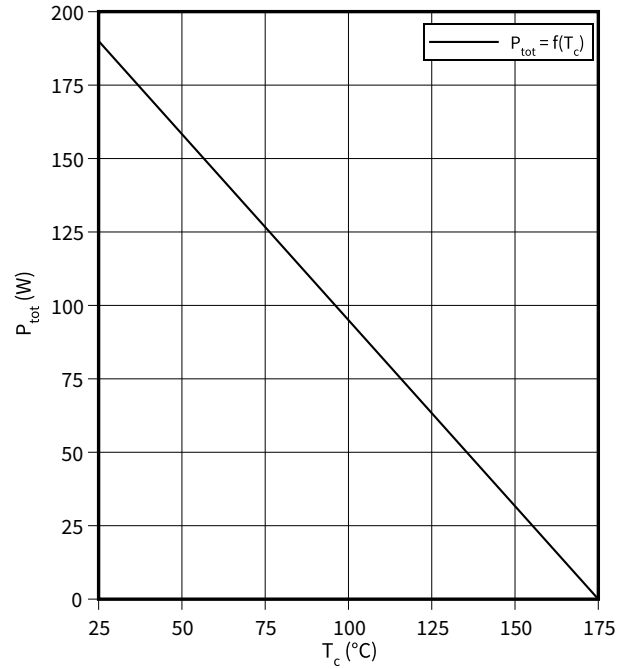
$t_p = 1 \mu s, D = 0, T_{vj} \leq 175^\circ C, T_C = 25^\circ C, V_{GE} = 15 V$



### Power dissipation as a function of case temperature, IGBT

$$P_{tot} = f(T_c)$$

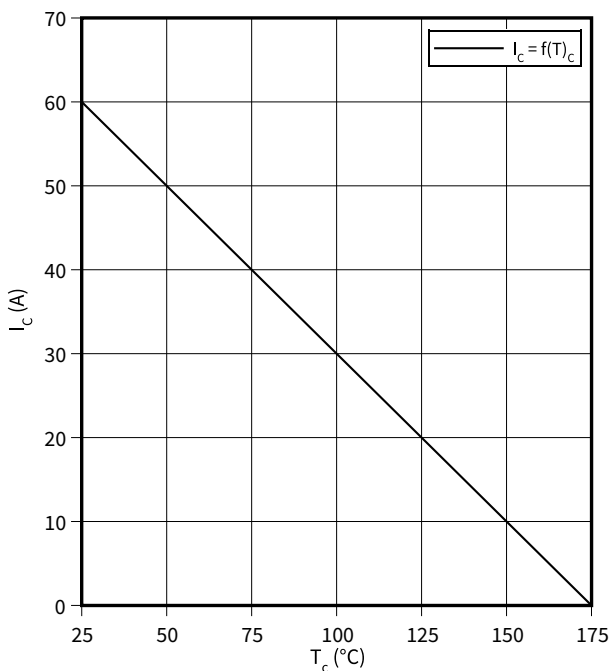
$T_{vj} \leq 175^\circ C$



### Collector current as a function of case temperature, IGBT

$$I_C = f(T_c)$$

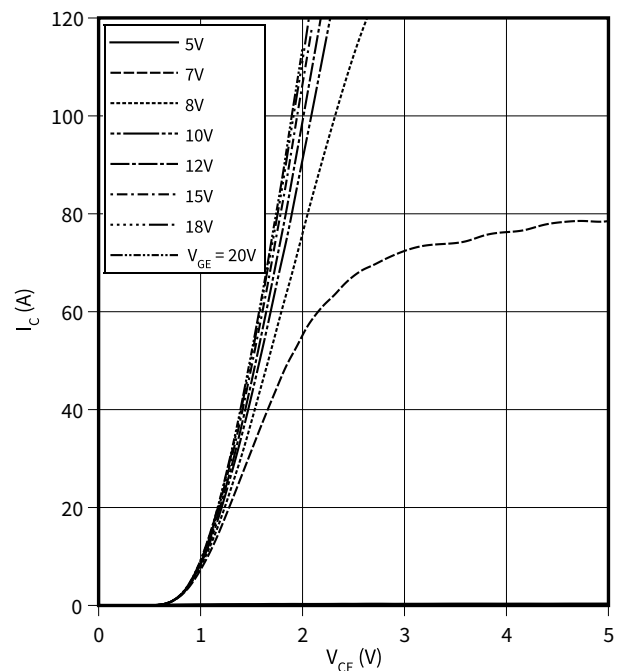
$T_{vj} \leq 175^\circ C, V_{GE} \geq 15 V$



### Typical output characteristic, IGBT

$$I_C = f(V_{CE})$$

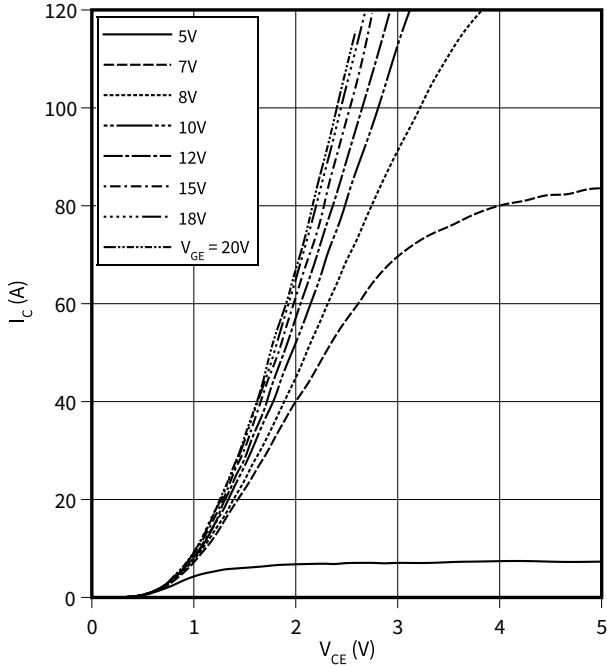
$T_{vj} = 25^\circ C$



4 Characteristics diagrams

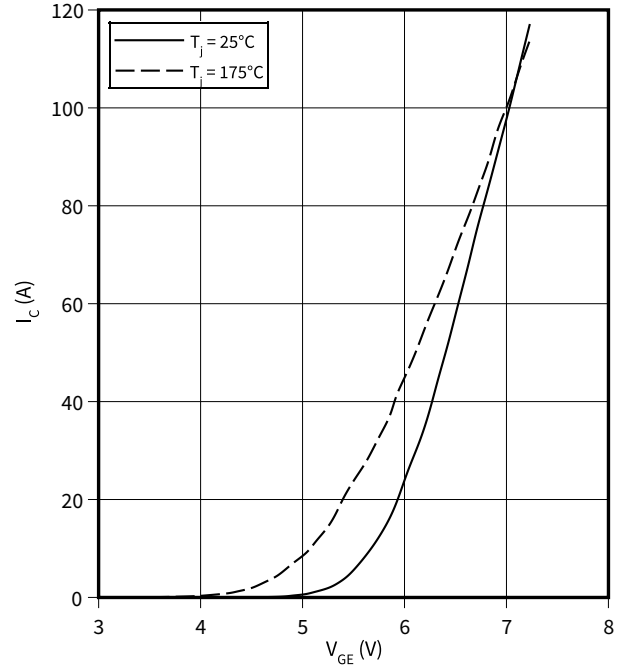
**Typical output characteristic, IGBT**

$I_C = f(V_{CE})$   
 $T_{vj} = 175\text{ °C}$



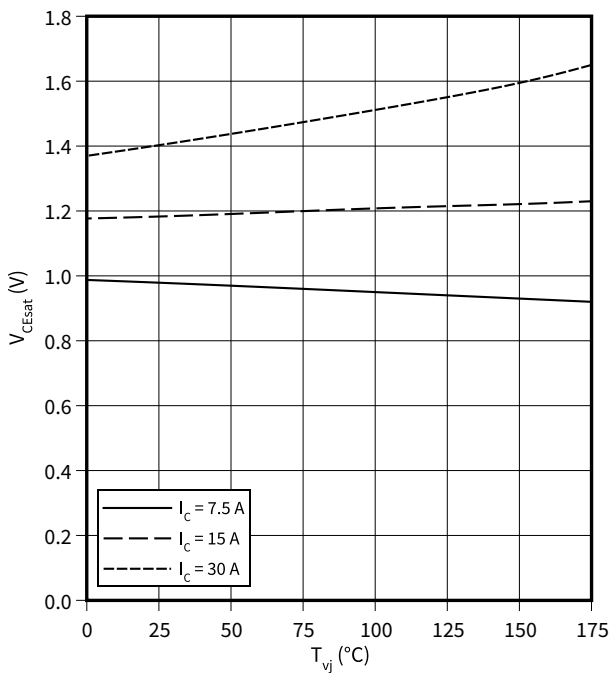
**Typical transfer characteristic, IGBT**

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



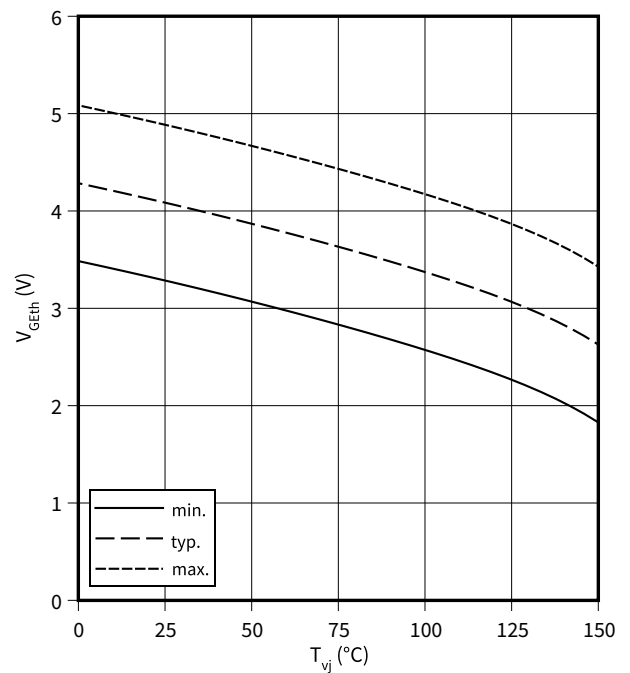
**Typical collector-emitter saturation voltage as a function of junction temperature, IGBT**

$V_{CEsat} = f(T_{vj})$   
 $V_{GE} = 15\text{ V}$



**Gate-emitter threshold voltage as a function of junction temperature, IGBT**

$V_{GEth} = f(T_{vj})$   
 $I_C = 0.20\text{ mA}$



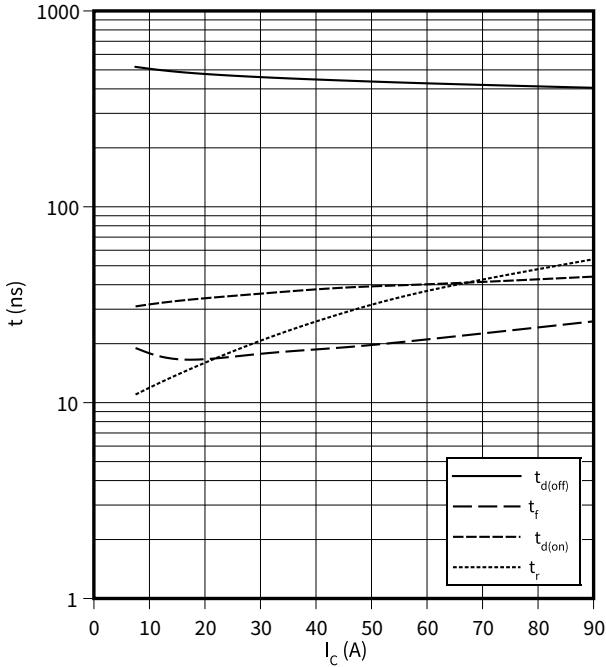


4 Characteristics diagrams

**Typical switching times as a function of collector current, IGBT**

$t = f(I_C)$

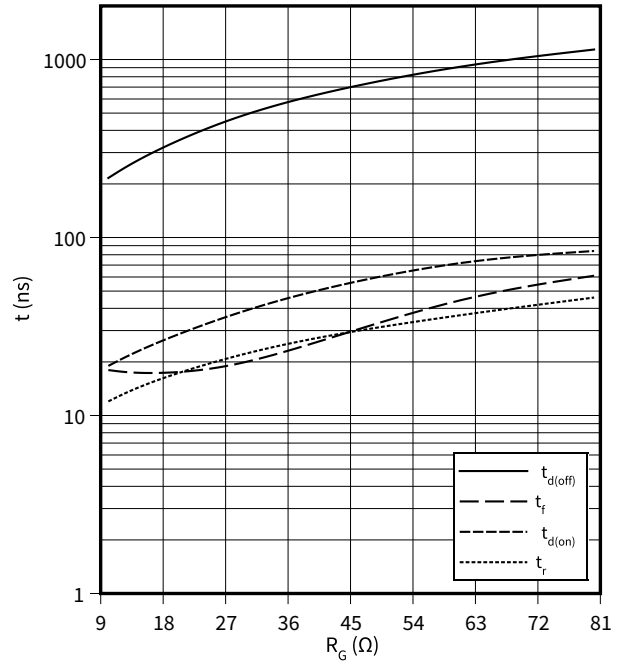
$V_{CE} = 400\text{ V}$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GE} = 0/15\text{ V}$ ,  $R_G = 27\text{ }\Omega$



**Typical switching times as a function of gate resistor, IGBT**

$t = f(R_G)$

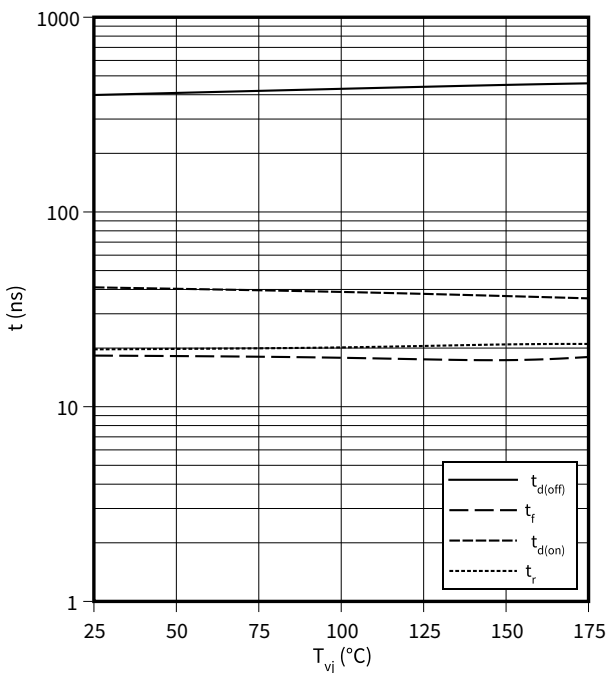
$I_C = 30.0\text{ A}$ ,  $V_{CE} = 400\text{ V}$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GE} = 0/15\text{ V}$



**Typical switching times as a function of junction temperature, IGBT**

$t = f(T_{vj})$

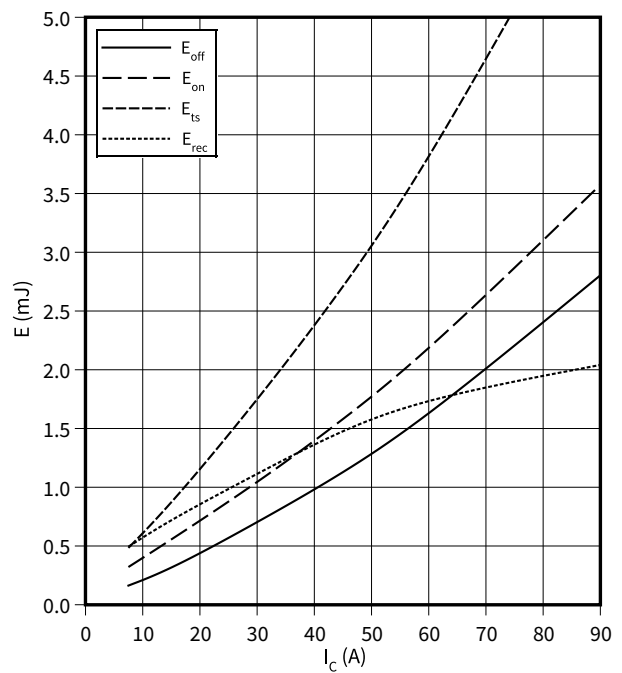
$I_C = 30.0\text{ A}$ ,  $V_{CE} = 400\text{ V}$ ,  $V_{GE} = 0/15\text{ V}$ ,  $R_G = 27\text{ }\Omega$



**Typical switching energy losses as a function of collector current, IGBT**

$E = f(I_C)$

$V_{CE} = 400\text{ V}$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GE} = 0/15\text{ V}$ ,  $R_G = 27\text{ }\Omega$

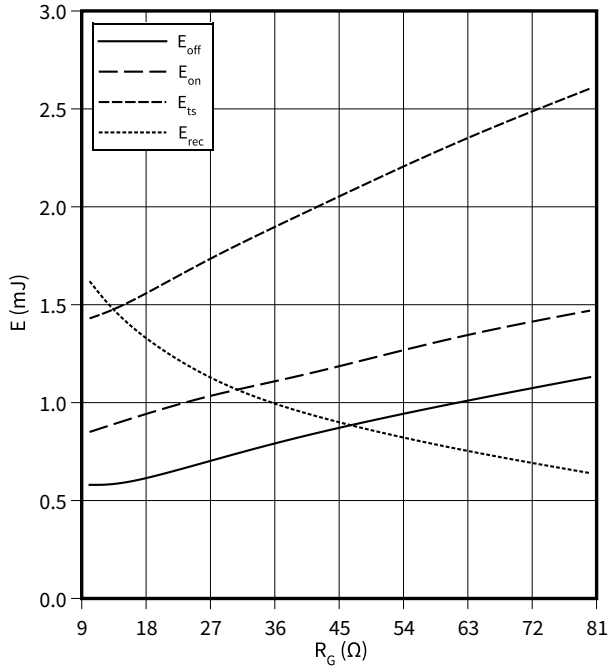


**4 Characteristics diagrams**

**Typical switching energy losses as a function of gate resistor, IGBT**

$E = f(R_G)$

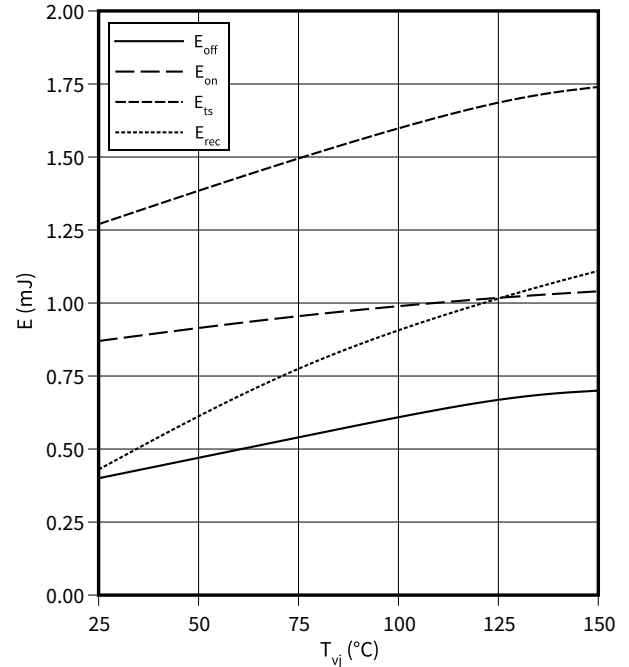
$I_C = 30.0\text{ A}$ ,  $V_{CE} = 400\text{ V}$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GE} = 0/15\text{ V}$



**Typical switching energy losses as a function of junction temperature, IGBT**

$E = f(T_{vj})$

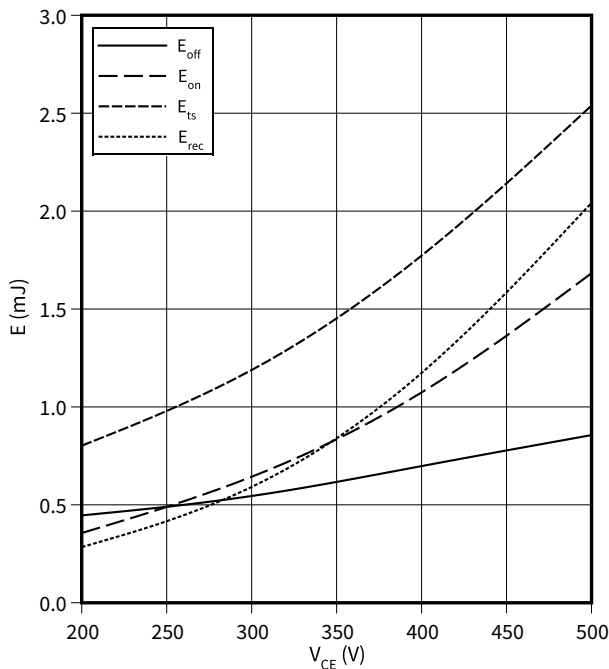
$I_C = 30.0\text{ A}$ ,  $V_{CE} = 400\text{ V}$ ,  $V_{GE} = 0/15\text{ V}$ ,  $R_G = 27\text{ Ω}$



**Typical switching energy losses as a function of collector emitter voltage, IGBT**

$E = f(V_{CE})$

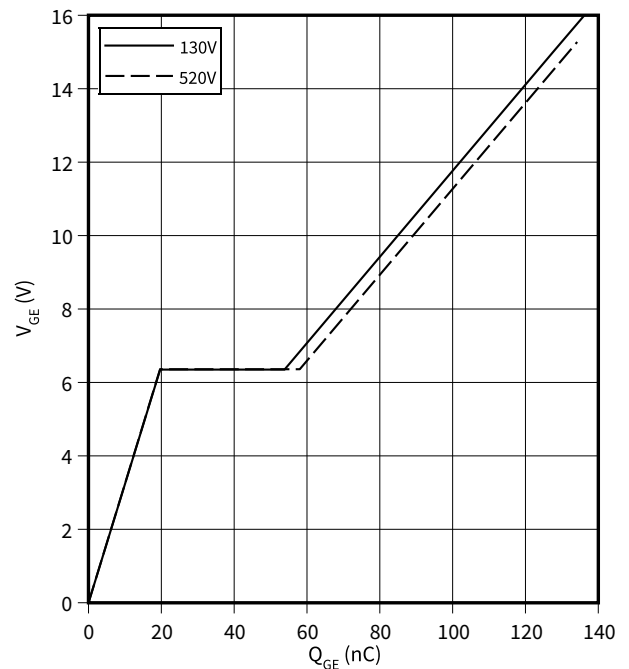
$I_C = 30.0\text{ A}$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GE} = 0/15\text{ V}$ ,  $R_G = 27\text{ Ω}$



**Typical gate charge, IGBT**

$V_{GE} = f(Q_{GE})$

$I_C = 30.0\text{ A}$

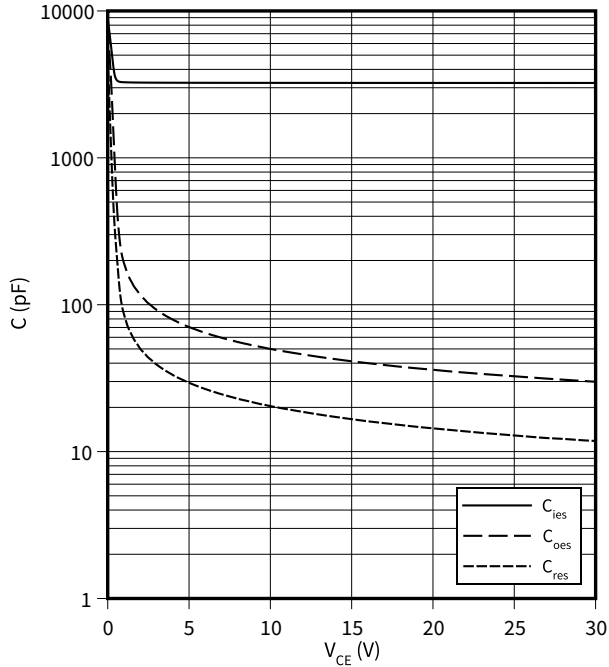


**4 Characteristics diagrams**

**Typical capacitance as a function of collector-emitter voltage, IGBT**

$C = f(V_{CE})$

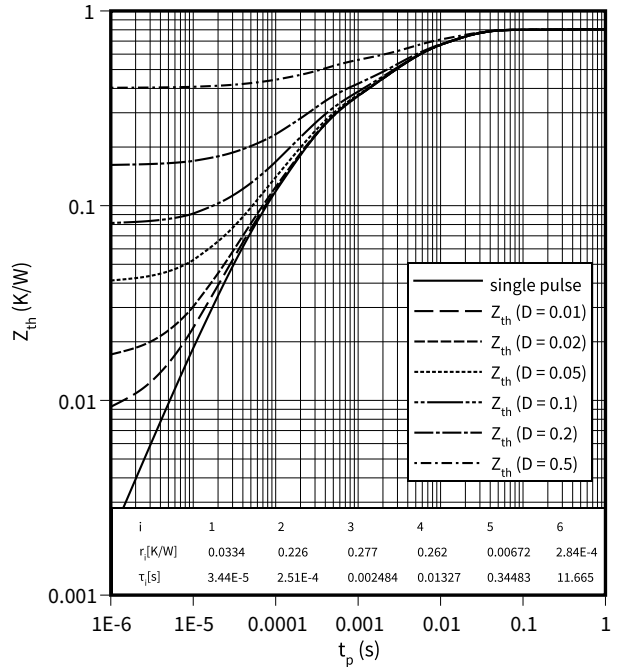
$f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}$



**IGBT transient thermal impedance as a function of pulse width, IGBT**

$Z_{th} = f(t_p)$

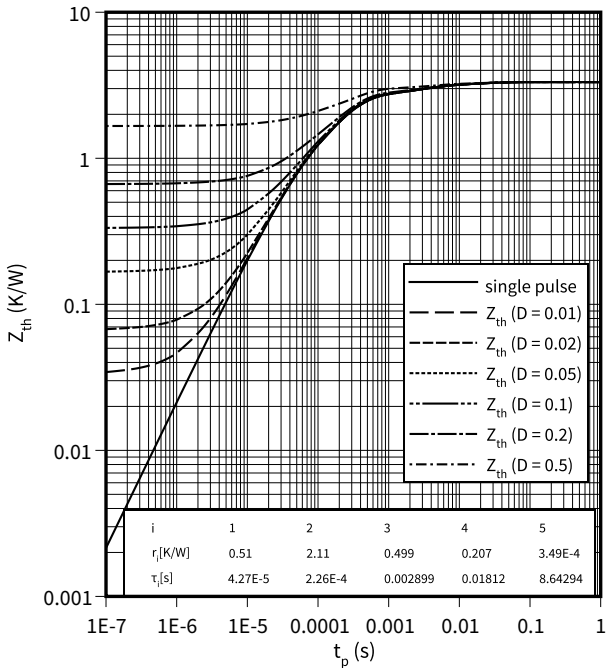
$D = t_p/T$



**Diode transient thermal impedance as a function of pulse width, Diode**

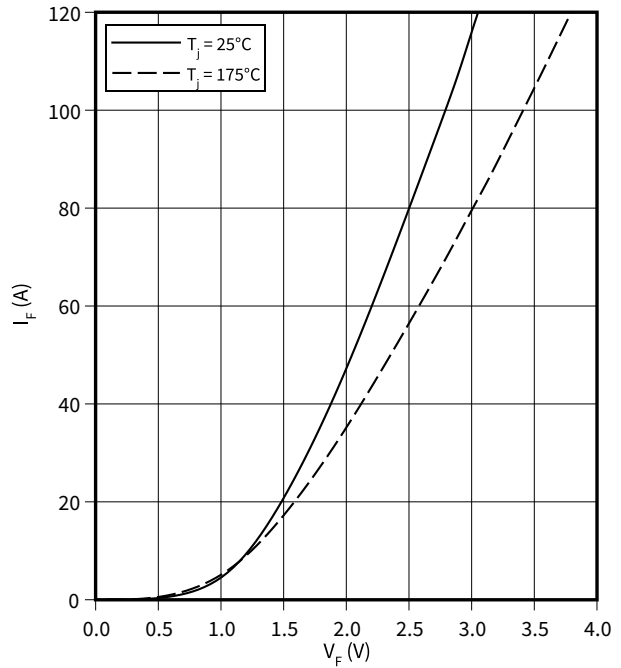
$Z_{th} = f(t_p)$

$D = t_p/T$



**Typical diode forward current as a function of forward voltage, Diode**

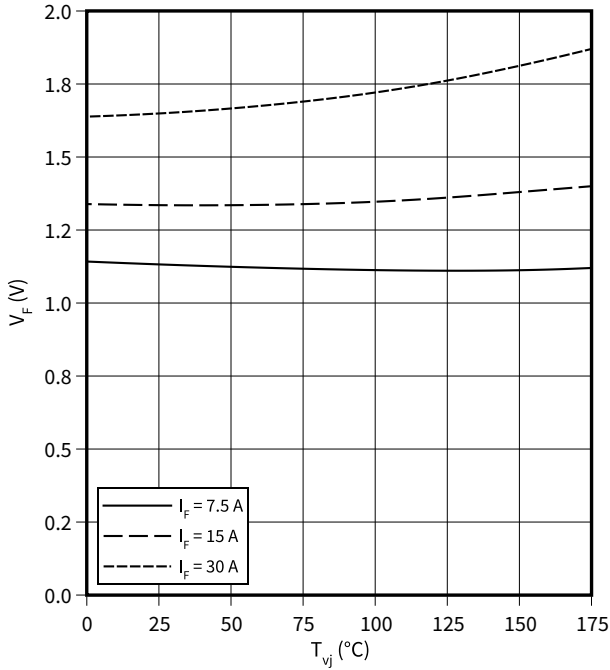
$I_F = f(V_F)$



4 Characteristics diagrams

**Typical diode forward voltage as a function of junction temperature, Diode**

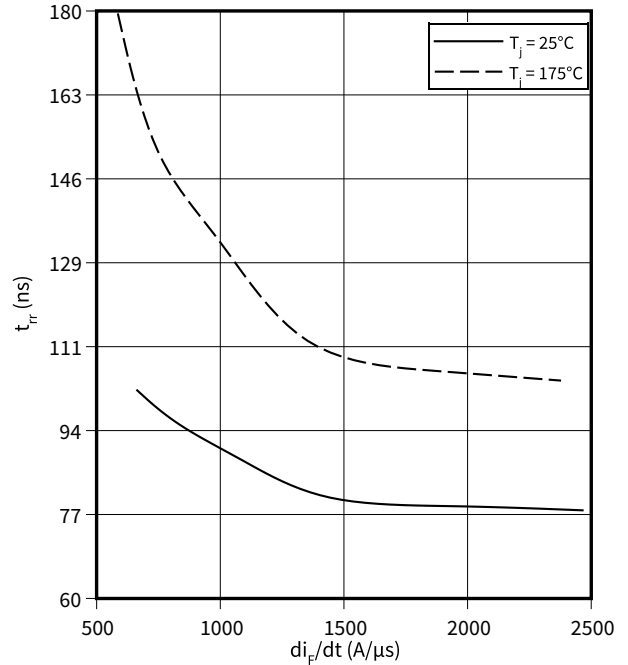
$V_F = f(T_{vj})$



**Typical reverse recovery time as a function of diode current slope, Diode**

$t_{rr} = f(di_F/dt)$

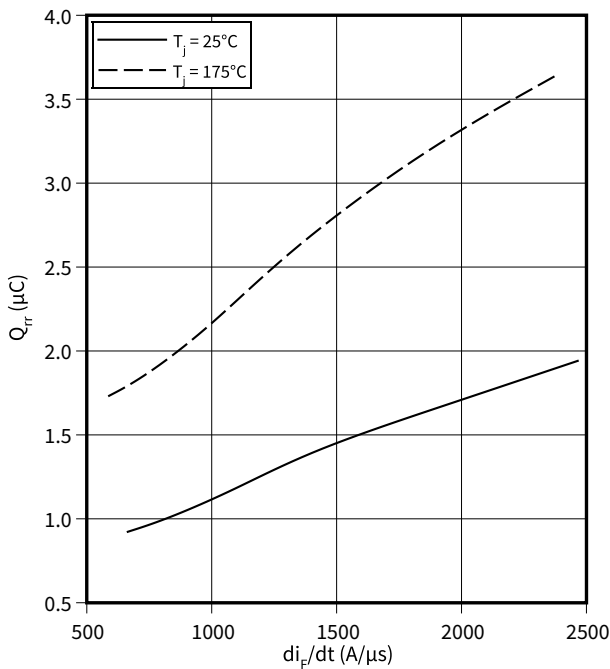
$V_R = 400$  V,  $I_F = 15$  A



**Typical reverse recovery charge as a function of diode current slope, Diode**

$Q_{rr} = f(di_F/dt)$

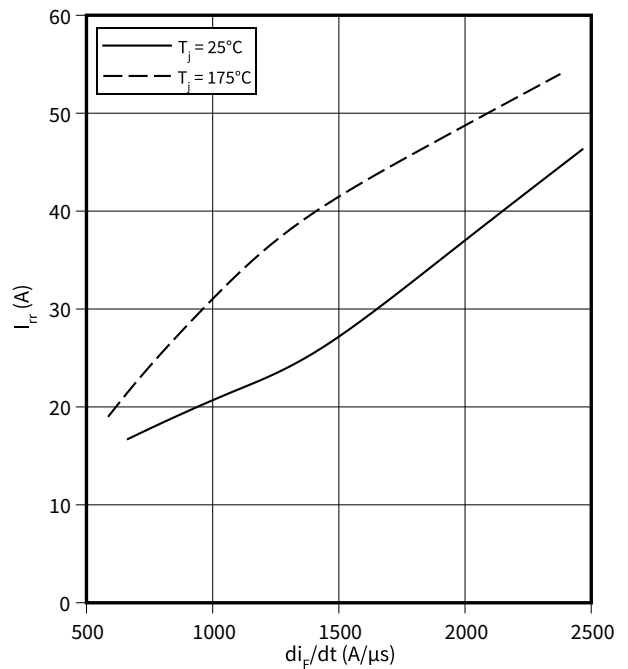
$V_R = 400$  V,  $I_F = 15$  A



**Typical reverse recovery current as a function of diode current slope, Diode**

$I_{rr} = f(di_F/dt)$

$V_R = 400$  V,  $I_F = 15$  A

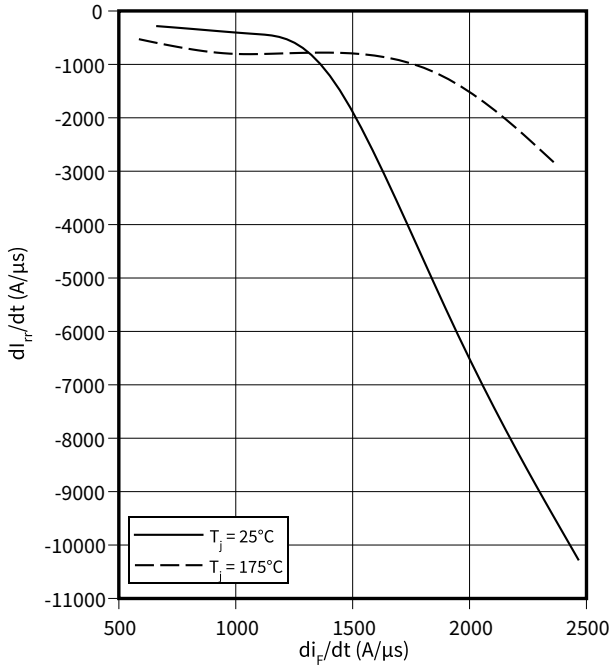


**4 Characteristics diagrams**

**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope, Diode**

$di_{rr}/dt = f(di_F/dt)$

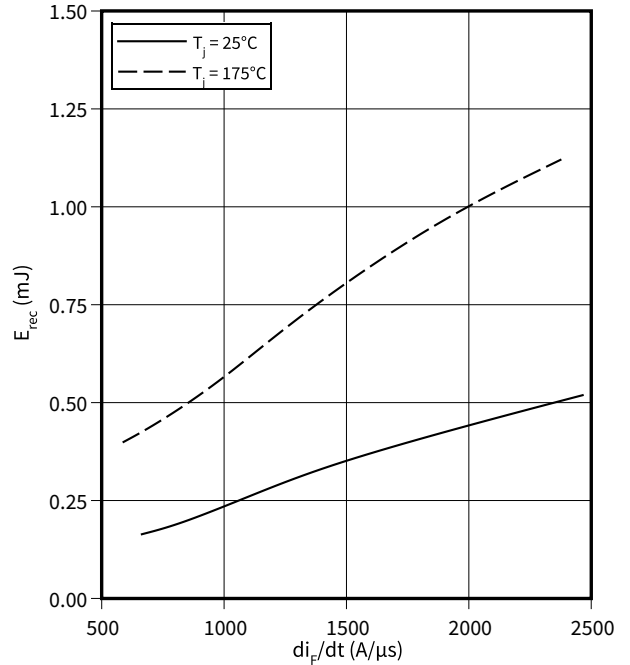
$V_R = 400\text{ V}, I_F = 15\text{ A}$



**Typical reverse energy losses as a function of diode current slope, Diode**

$E_{rec} = f(di_F/dt)$

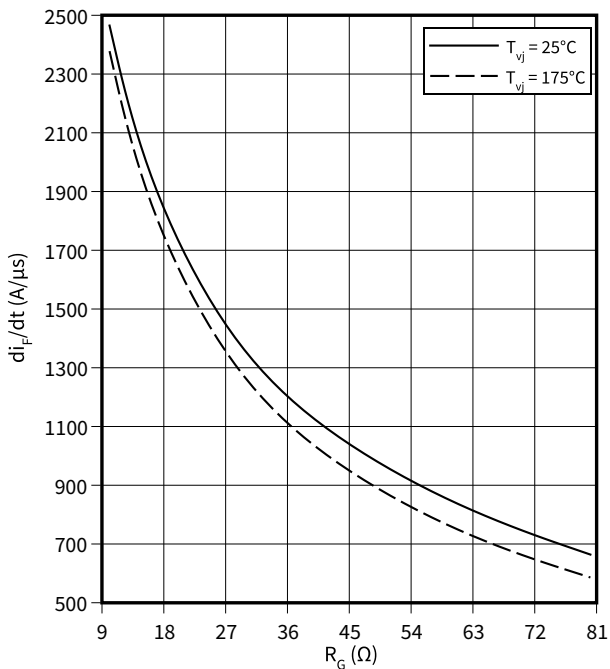
$V_R = 400\text{ V}, I_F = 15\text{ A}$



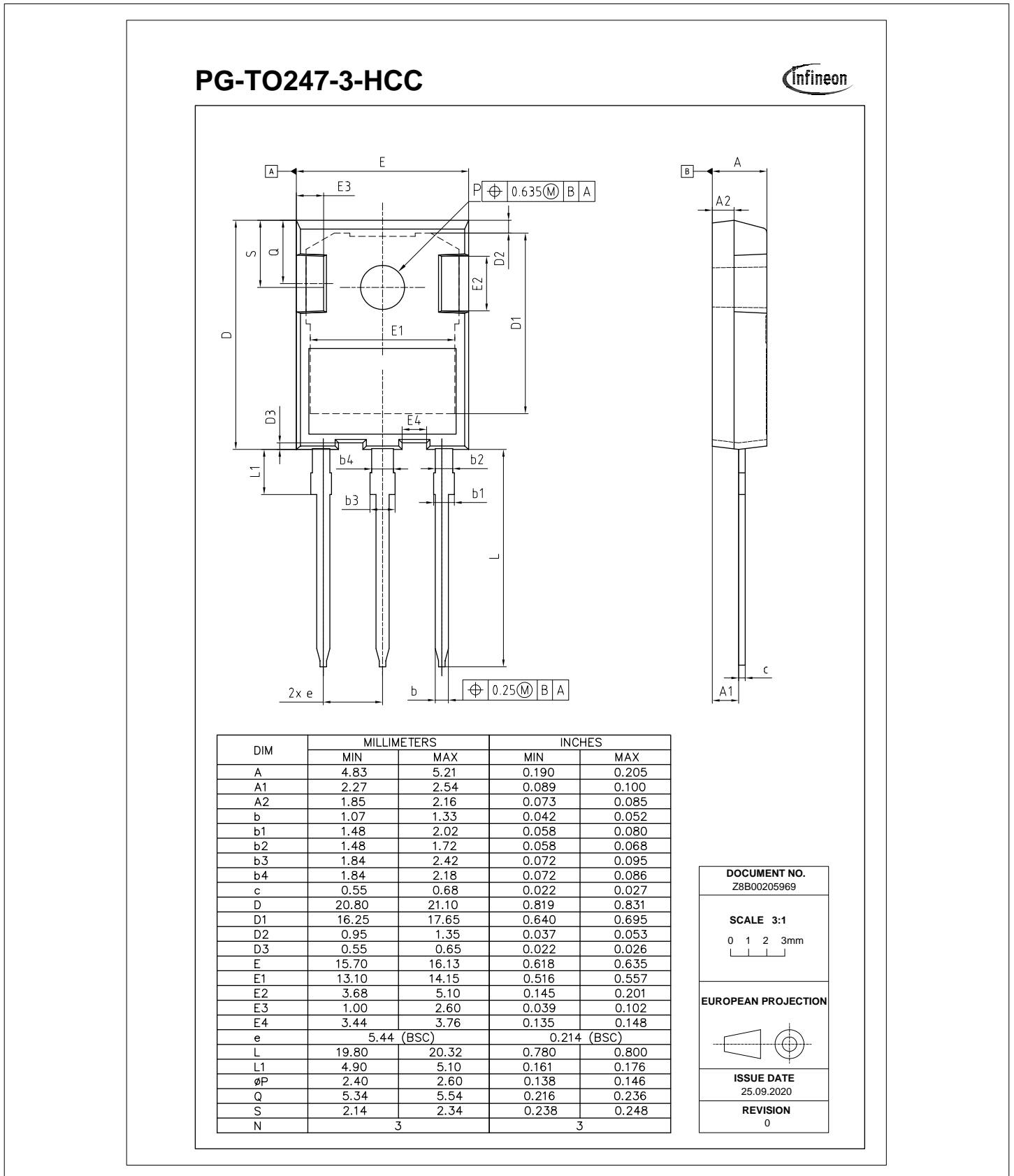
**Typical diode current slope as a function of gate resistor, Diode**

$di_F/dt = f(R_G)$

$V_R = 400\text{ V}, I_F = 15\text{ A}$



**5 Package outlines**



**Figure 6**

## 6 Testing conditions

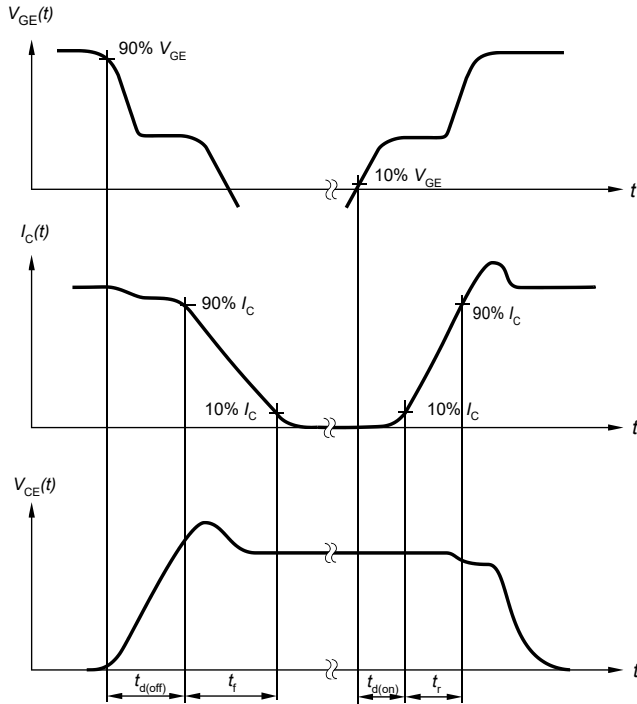


Figure A. Definition of switching times

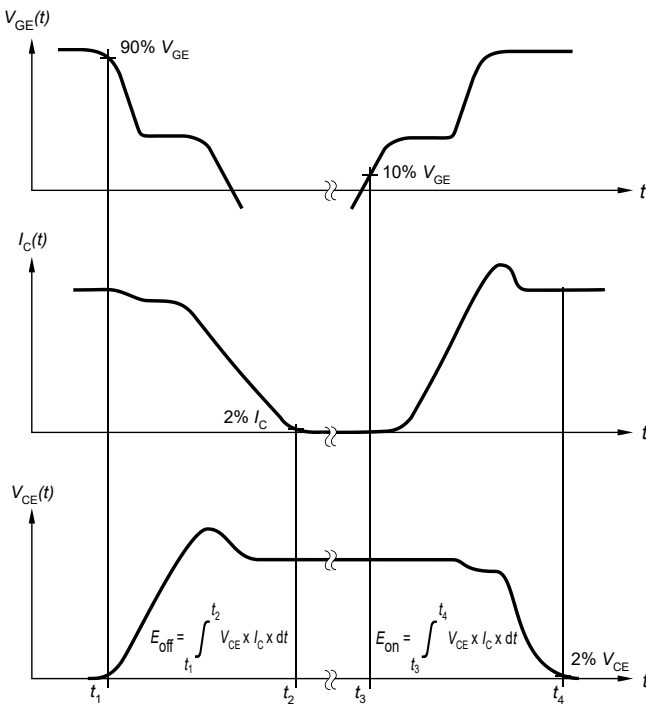


Figure B. Definition of switching losses

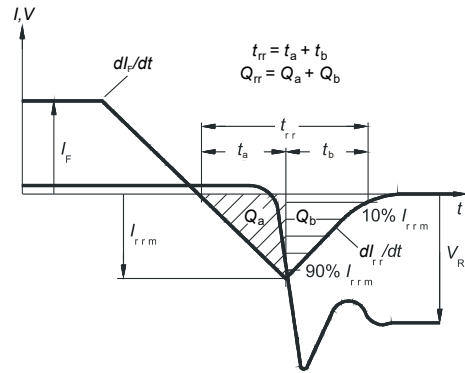


Figure C. Definition of diode switching characteristics

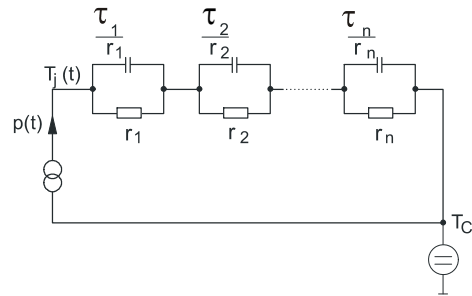


Figure D. Thermal equivalent circuit

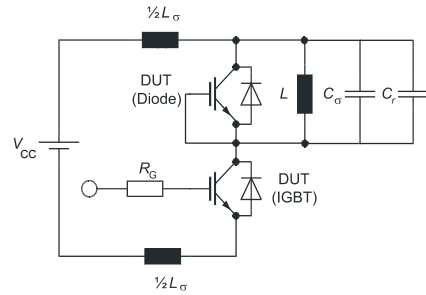


Figure E. Dynamic test circuit  
 Parasitic inductance  $L_{\sigma}$ ,  
 parasitic capacitor  $C_{\sigma}$ ,  
 relief capacitor  $C_r$ ,  
 (only for ZVT switching)

Figure 7

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Revision history

## Revision history

Document revision	Date of release	Description of changes
1.00	2021-05-17	Initial version
1.10	2021-05-18	Final datasheet



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